SUM60061EL

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Vishay Siliconix

TO-263

PRODUCT SUMMARY						
V _{DS} (V)	-80					
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.0061					
$R_{DS(on)}$ max. (Ω) at V_GS = -4.5 V	0.0086					
Q _g typ. (nC)	145					
I _D (A)	-150					
Configuration	Single					

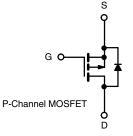
FEATURES

P-Channel 80 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- Package with low thermal resistance
- Maximum 175 °C junction temperature
- Low R_{DS(on)} minimizes power loss from **FREE** conduction
- · Compatible with logic-level gate driving
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Battery protection
- Motor drive control
- Load switch



ORDERING INFORMATION				
Package	TO-263			
Lead (Pb)-free and halogen-free	SUM60061EL-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage	V _{DS}	-80	v		
Gate-source voltage	V _{GS}	± 20	v		
Continuous drain current ^d	T _C = 25 °C		-150 ^d		
(T _J = 175 °C)	T _C = 70 °C	I _D	-150 ^d		
Pulsed drain current (100 µs)	I _{DM}	-250	- A		
Avalanche current	L = 0.1 mH	I _{AS}	-75		
Single pulse avalanche energy ^a	L = 0.1 MH	E _{AS}	281	mJ	
Power dissipation	T _C = 25 °C °	P	375	14/	
	T _C = 125 °C ^b	PD	125	W	
Operating junction and storage temperature range	•	T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount ^b	R _{thJA}	40	°C/W	
Junction-to-case		R _{thJC}	0.4	C/W	

Notes

- a. Duty cycle ≤ 1 %
- b. When mounted on 1" square PCB (FR4 material)
- c. See SOA curve for voltage derating
- d. Limited by package

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = -10 mA$	-80	-	-	V	
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-1.5	-	-2.5	V	
Gate-body leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
		$V_{DS} = -80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-10	μΑ	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = -64 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$	-	-	-50		
-		$V_{DS} = -64 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 \text{ °C}$	-	-	-250		
On-state drain current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	-30	-	-	А	
Drain-source on-state resistance ^a	Passa	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -20 \text{ A}$	-	0.0051	0.0061	0	
Drain-source on-state resistance "	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -15 \text{ A}$	-	0.0069	0.0086	Ω	
Forward transconductance a	9 _{fs}	V _{DS} = -15 V, I _D = -15 A	-	80	-	S	
Dynamic ^b							
Input capacitance	C _{iss}		-	9600	-	pF	
Output capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = -40 V, f = 1 MHz	-	3300	-		
Reverse transfer capacitance	C _{rss}		-	110	-		
Total gate charge ^c	Qg		-	145	218	nC	
Gate-source charge ^c	Q _{gs}	V_{DS} = -40 V, V_{GS} = -10 V, I_{D} = -110 A	-	34	-		
Gate-drain charge ^c	Q _{gd}		-	16	-		
Gate resistance	Rg	f = 1 MHz	0.46	2.3	4.6	Ω	
Turn-on delay time ^c	t _{d(on)}		-	25	35		
Rise time ^c	t _r	V_{DD} = -40 V, R_L = 0.71 Ω	-	20	30		
Turn-off delay time ^c	t _{d(off)}	$I_D\cong$ -20 A, V_{GEN} = -10 V, R_g = 1 Ω	-	90	140	ns	
Fall time ^c	t _f		-	20	30		
Drain-Source Body Diode Character	ristics (T _C = 25	o °C ^b)					
Continuous current	IS		-	-	-150	A	
Pulsed current	I _{SM}		-	-	-250	Л	
Forward voltage ^a	V _{SD}	$I_{F} = -10 \text{ A}, V_{GS} = 0 \text{ V}$	-	-0.8	-1.5	V	
Reverse recovery time	t _{rr}		-	90	135	ns	
Peak reverse recovery charge	I _{RM(REC)}	I _F = -20 A, dl/dt = 100 A/µs	-	-2.8	-4.2	Α	
Reverse recovery charge	Q _{rr}		-	145	218	nC	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

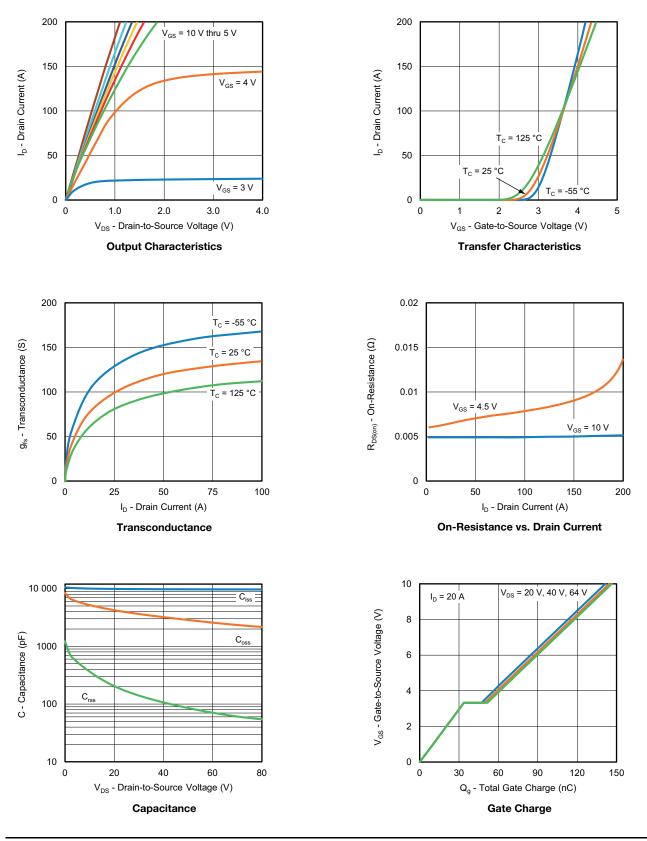
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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



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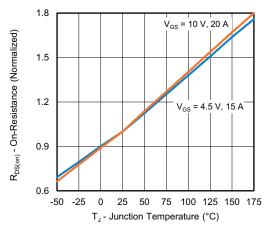
3 questions contact: pmostechsupport Document Number: 63024

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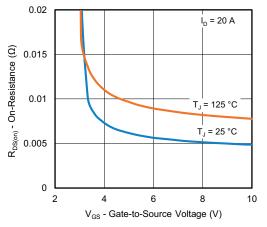


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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



On-Resistance vs. Junction Temperature



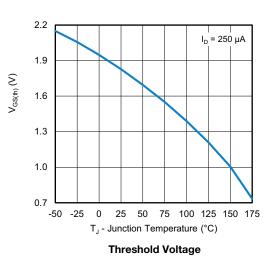
On-Resistance vs. Gate-to-Source Voltage

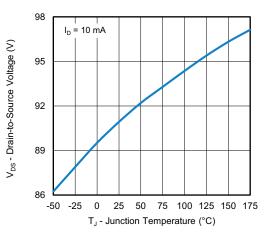
T = 25 °C

0.8

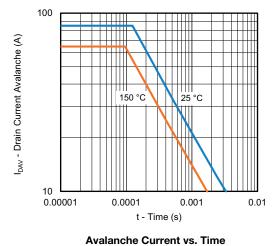
1.0

1.2





Drain Source Breakdown vs. Junction Temperature



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100

10

1

0.1

0.01

0

0.2

0.4

0.6

V_{SD} - Source-to-Drain Voltage (V)

Source Drain Diode Forward Voltage

T₁ = 150 °C

Is - Source Current (A)

4

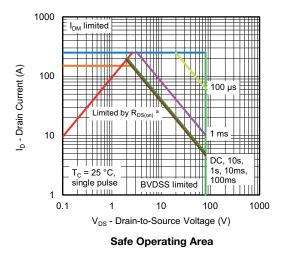
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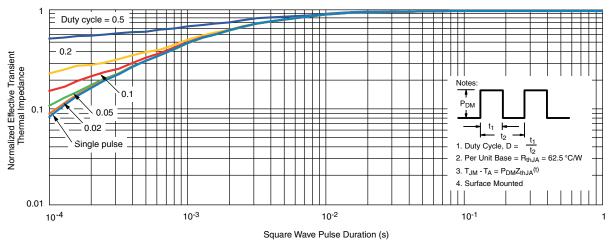
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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



Normalized Thermal Transient Impedance, Junction-to-Case

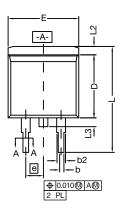
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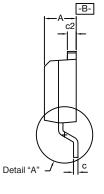
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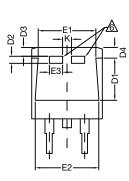


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TO-263 (D²PAK): 3-LEAD

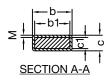








DETAIL A (ROTATED 90°)



		INC	HES	MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
А		0.160	0.190	4.064	4.826	
b		0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
с*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
	D3	0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	E	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
E2		0.355	0.375	9.017	9.525	
E3		0.072	0.078	1.829	1.981	
	е	0.100 BSC		2.54 BSC		
К		0.045	0.055	1.143	1.397	
L		0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
L2		0.040	0.055	1.016	1.397	
L3		0.050	0.070	1.270	1.778	
L4		0.010 BSC		0.254 BSC		
М		-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843						

Notes

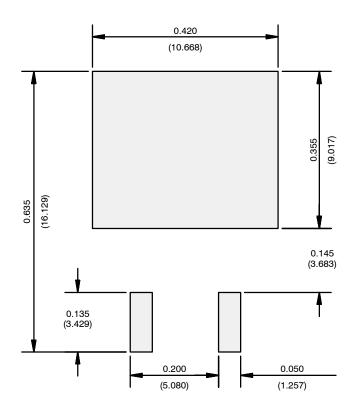
- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25 $\,\%\,$ of L1 can fall above seating plane by
- max. 8 mils. 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
 - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

This feature is for thick lead.

Revison: 30-Sep-13



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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